Product data sheet

1. Product profile

1.1 General description

Planar Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a hermetically-sealed subminiature SOD68 (DO-34) package. The diode is suitable for mounting on a 2 E (5.08 mm) pitch.

1.2 Features and benefits

- Low forward voltage
- Guard ring protected
- Hermetically-sealed leaded glass package

1.3 Applications

- Ultra high-speed switching
- Voltage clamping
- Protection circuits
- Blocking diodes

1.4 Quick reference data

Table 1. Q	uick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5 ; f = 20 kHz; T _{amb} ≤ 50 °C; PCB mounting, lead length = 4 mm	-	-	200	mA
V _R	reverse voltage		-	-	50	V
V _F	forward voltage	I _F = 10 mA; T _{amb} = 25 °C	-	-	450	mV

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode[1]	k k k k k k k k k k k k k k	K F A
2	A	anode	DO-34 (SOD68)	aaa-003679

[1] The marking band indicates the cathode.





3. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
BAT86	DO-34	hermetically sealed glass package; axial leaded; 2 leads	SOD68				

4. Marking

Table 4. Marking codes	
Type number	Marking code
BAT86	marking band

5. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _R	reverse voltage		-	50	V
l _F	forward current		-	200	mA
I _{F(AV)}	average forward current	δ = 0.5 ; f = 20 kHz; T _{amb} ≤ 50 °C; PCB mounting, lead length = 4 mm	-	200	mA
I _{FRM}	repetitive peak forward current	t _p ≤ 1 s; δ ≤ 0.5	-	500	mA
I _{FSM}	non-repetitive peak forward current	$t_p \le 10 \text{ ms; } T_{j(init)} = 25 \text{ °C}$	-	5	A
Tj	junction temperature		-	125	°C
T _{amb}	ambient temperature		-65	125	°C
T _{stg}	storage temperature		-65	150	°C

6. Thermal characteristics

Table 6. Th	ermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	320	K/W

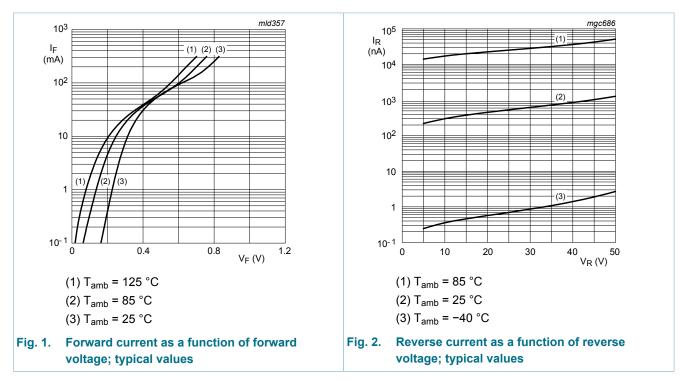
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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Schottky barrier single diode

7. Characteristics

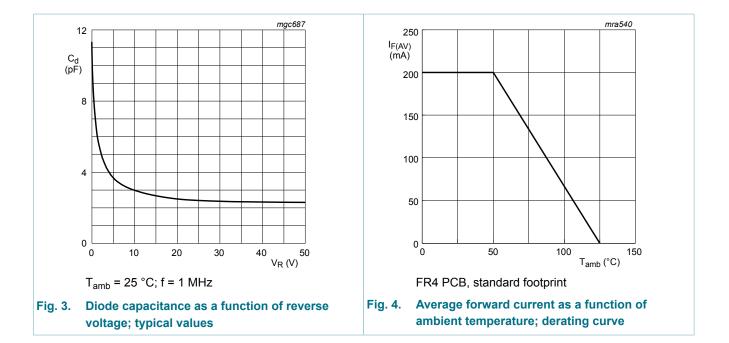
Table 7. Ch	aracteristics					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V _F	forward voltage	I _F = 0.1 mA; T _{amb} = 25 °C	-	-	300	mV
		I _F = 1 mA; T _{amb} = 25 °C	-	-	380	mV
		I _F = 10 mA; T _{amb} = 25 °C	-	-	450	mV
		I _F = 30 mA; T _{amb} = 25 °C	-	-	600	mV
		I _F = 100 mA; T _{amb} = 25 °C	-	-	900	mV
I _R	reverse current	V_R = 40 V; T _{amb} = 25 °C; pulsed; t _p = 300 µs; δ = 0.02	-	-	5	μA
C _d	diode capacitance	f = 1 MHz; T _{amb} = 25 °C; V _R = 1 V	-	-	8	pF
t _{rr}	reverse recovery time	I_F = 10 mA; I_R = 10 mA; R_L = 100 Ω; $I_{R(meas)}$ = 1 mA; T_{amb} = 25 °C	-	-	4	ns



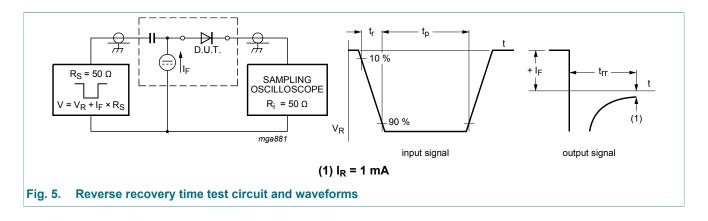
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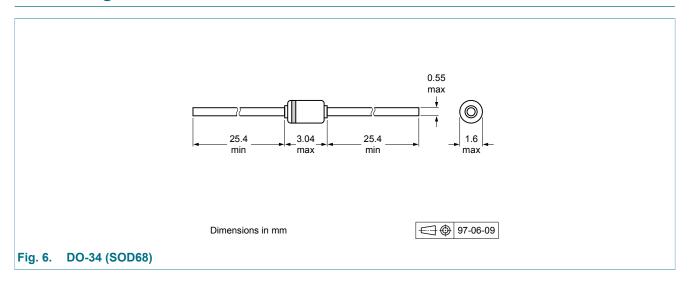
8. Test information



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Schottky barrier single diode

9. Package outline



10. Revision history

Table 8. Revision his	story						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
BAT86 v.3	20120725	Product data sheet	-	BAT86 v.2			
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Section "Marking" added Package outline drawing replaced by minimized package ouline drawing Section "Test information" added 						
BAT86 v.2	20000525	Product specification	-	BAT86 v.1			
BAT86 v.1	19960320	Product specification	-	-			

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11. Legal information

11.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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